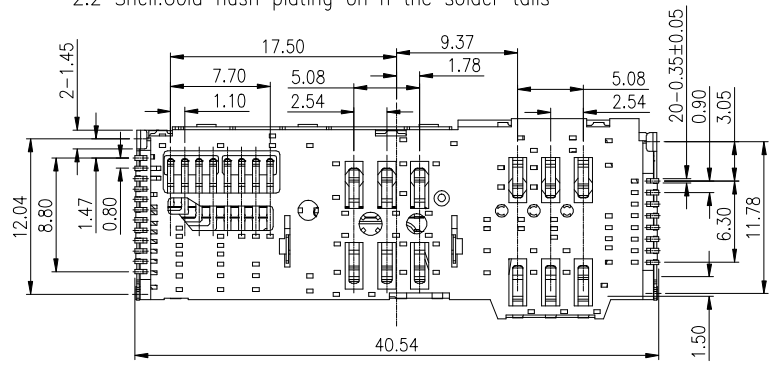
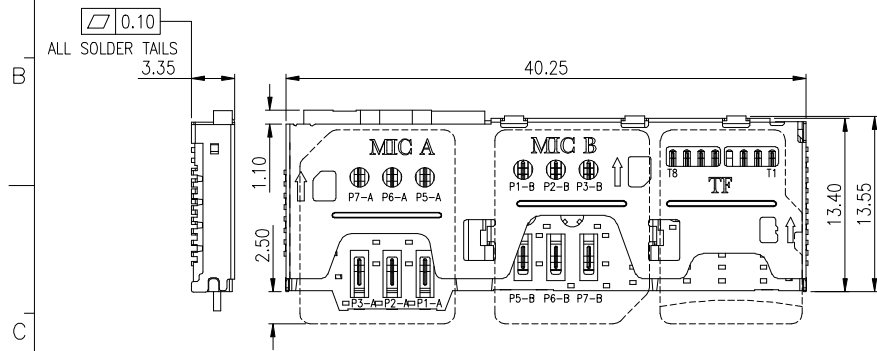
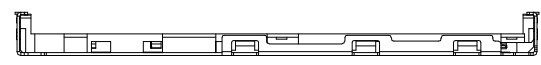


REV	LOCAS	DESCRIPTION	DRAW	DATE
AO	NEW	PERLIMINARY	Andy	2019.08.16
A1		MODIFY	Andy	2019.09.06
A2			LIU	2021.09.03

NOTES:

- 1.MATERIAL:
 1.1 Housing: High Temperature Thermoplastic UL94V-0,
 1.2 Terminal:Copper Alloy,T=0.15mm
 1.3 Shell:Stainless Steel,T=0.20mm
- 2.FINISH:
 2.1 Terminal:Gold flash plating on contact area,
 Gold flash plating on the solder tails,
 2.2 Shell:Gold flash plating on n the solder tails



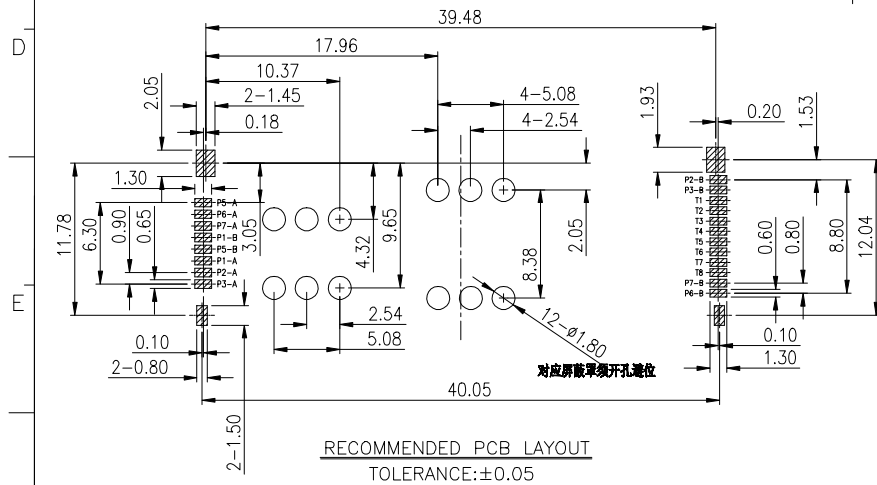
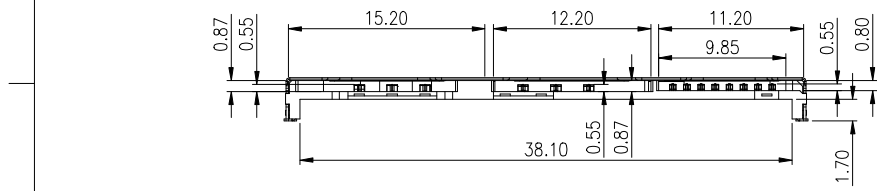
T-CARD PIN NO	PIN DEFINITION
PIN 1	DAT2
PIN 2	CD/DAT3
PIN 3	CMD
PIN 4	VDD
PIN 5	CLK
PIN 6	VSS
PIN 7	DAT0
PIN 8	DAT1

SIM CARD PIN NO	PIN DEFINITION
PIN 1-A/B	VCC
PIN 2-A/B	RST
PIN 3-A/B	CLK
PIN 5-A/B	GND
PIN 6-A/B	VPP
PIN 7-A/B	I/O

Ordering Information

S A 20 06 254 335 -73-02

- S:SIM Card Series
 A:Finished Product
 No.of PINS:20(20PIN)
 Plating Number
- Running Number
 335:Height 3.35mm
 254:Pitch 2.54mm



MEASURE POINT: QUADRANT POINT (QP) TANGENCY POINT (TP) INTERSECTION POINT (IP)	DongGuan D-CHAIN Precision Components CO, Ltd		DESIGN	Andy	DATE	2019.08.16	TITLE:	3.35H 3 IN 1 CARD (DUAL MICRO SIM CARD+TF CARD)		
			CHECKED		DATE					
UNLESS OTHERWISE SPECIFIED,TOLERANCE: X. ±0.25 X.x ±0.20 X.xx ±0.10 ANGULAR ±3'	APPROVED		DATE							
	PART No.	SA2006254335-73-02				REV:	A2	SCALE:	2:1	UNIT:
	DRAWING No.					SIZE:	A4	SHEET:	1/1	